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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Applicant:	Ilya Karpov et al.	§ Art Unit:	2814
Serial No.:	10/822,361	§ Examiner:	Long Pham
Filed:	April 12, 2004	§ Docket:	ITL.0835D1US P14730D
For:	Fabricating Deeper and Shallower Trenches in Semiconductor Structures	§ Assignee:	Intel Corporation
		§ Conf. No.	3077

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Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

SUPPLEMENTAL REPLY TO FINAL REJECTION

Sir:

In further response to the final rejection mailed August 15, 2007, please amend the above-referenced patent application as follows:

Date of Deposit: October 19, 2007
I hereby certify that this document is being facsimile transmitted to the United States Patent and Trademark Office (Fax No. 571/273-8300) on the date indicated above.

Cynthia L. Hayden
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